



**ENTERPRISE X-SERIES** 

# Feature-Rich PCIe Gen 5 Enterprise Storage Solutions

The Miphi X200 exists to support your diverse requirements in a single series. X200 delivers both singleport and dual-port modes while shipping in U.2 2.5" and E3.S form factors to give your data center reliable, and predictable performance that exceeds industry standards.



#### **Product Features**

- PCIe 5.0 1x4 / 2x2 (Dual port)
- NVMe 2.0
- Capacity up to 30.72TB
- Form Factor: U.2 / E3.S
- DWPD: 1 / 3
- 128 Namespaces
- Power Loss Protection (PLP)
- ISE, TCG Opal 2.0 Support
- AES-XTS 256-bit Encryption
- End-to-End Data Path Protection
- Metadata Protection
- SECDED
- Sanitize
- NVMe-MI (Management Interface)
- SMBus

#### Sequential Performance Read 14,800 MB/s

Read 8,700K MB/s

Random Performance Read 3,000K IOPS

Write 900K IOPS



### Solution MP-X200E

Interface     PCle 5.0 1x4, 2x2     P	25.6TB 5.0 1x4, 2x2 2.0 3D TLC ,000 (Est.) 500 (Est.) 300K (Est.)							
NVMe     2.0     2.0     2.0     2.0       NAND Flash     3D TLC     3D TLC     3D TLC     3D TLC     3D TLC       Sequential Read(MB/s)     14,800	2.0 3D TLC ,000 (Est.) 500 (Est.) 300K (Est.)							
NAND Flash     3D TLC     3D TLC     3D TLC     3D TLC     3D TLC     3D TLC       Performance <sup>(2,3,4,6)</sup> Sequential Read(MB/s)     14,800	3D TLC ,000 (Est.) 500 (Est.) 800K (Est.) 30K (Est.)							
Performance <sup>(2,3,4,6)</sup> Sequential Read(MB/s)     14,800     14,80	,000 (Est.) 500 (Est.) 800K (Est.) 30K (Est.)							
Sequential Read(MB/s)     14,800	500 (Est.) 300K (Est.) 30K (Est.)							
Sequential Write(MB/s)     4,300     8,600     8,700     8,350     7,4       4K Random Read(IOPS)     2400K     3,000K     3,000K     3,000K     2,3       16K Random Write(IOPS)     400K     800K     900K     900K     63	500 (Est.) 300K (Est.) 30K (Est.)							
4K Random Read(IOPS)     2400K     3,000K     3,000K     3,000K     2,3       16K Random Write(IOPS)     400K     800K     900K     900K     63	300K (Est.) 30K (Est.)							
16K Random Write(IOPS) 400K 800K 900K 900K 65	30K (Est.)							
	. ,							
Read Latency (Typ., μs) 60 60 60 60								
	60							
Write Latency (Typ., μs)     10     10     10     10	10							
Power Consumption <sup>(5,6)</sup>								
Active (W) <25 <25 <25 <25	<25							
Idle (W) 5 5 5 5	5							
Endurance/Reliability								
DWPD 3 3 3 3	3							
< 1 sector per < 1	sector per							
	bits read							
MTBF (million hours) 2.5 2.5 2.5 2.5	2.5							
Limited Warranty (years) 5 5 5 5	5							
Temperature								
Operating Temp. (°C) 0 - 70 0 - 70 0 - 70 0 - 70	0 - 70							
Non-Operating Temp. (°C)     -40 - 85     -40 - 85     -40 - 85     -40 - 85	-40 - 85							
Physical Dimension								
Length (mm) 100.10 100.10 100.10 100.10	100.10							
Width (mm)     69.85     69.85     69.85     69.85	69.85							
Height (mm) 15.00 15.00 15.00 15.00	15.00							
Weight (g)     188     199     201     168	<250							

 (1) The product is still in the early development stage, all values provided are based on estimation.
(2) 1 TB = 1012 bytes.
(3) Sequential Performance is based on FIO on Linux, 128KB, with QD=32, 1 worker , and test drive set as secondary.
(4) Random Performance is based on FIO on Linux, 4KB data size, QD=32, 16 workers.
(5) Latency is measured with random workloads based on FIO on Linux, 4KB data size, QD=1, 1 worker.
(6) Power consumption (Maximum RMS) is measured during the sequential read/write and random read/write operations performed by iometer with the constituent development in a diversional development. conditions described in (2)(3).

(7) The results of DWPD are obtained in compliance with JESD219A Standards.



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# Solution MP-X200E

Form Factor		E3	.S						
Capacity(1)	1.6TB	3.2TB	6.4TB	12.8TB					
Interface	PCIe 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2					
NVMe	2.0	2.0	2.0	2.0					
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC					
Performance <sup>(2,3,4,6)</sup>									
Sequential Read(MB/s)	14,800	14,800	14,800	14,800					
Sequential Write(MB/s)	4,300	8,600	8,700	8,350					
4K Random Read(IOPS)	2,400K	3,000K	3,000K	3,000K					
16K Random Write(IOPS)	400K	800K	900K	900K					
Read Latency (Typ., µs)	60	60	60	60					
Write Latency (Typ., µs)	10	10	10	10					
Power Consumption <sup>(5,6)</sup>									
Active (W)	<25	<25	<25	<25					
Idle (W)	5	5	5	5					
Endurance/Reliability									
DWPD(7)	3	3	3	3					
UBER	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per					
	10 <sup>18</sup> bits read	1 <sup>18</sup> bits read	10 <sup>18</sup> bits read	10 <sup>18</sup> bits read					
MTBF (million hours)	2.5	2.5	2.5	2.5					
Limited Warranty (years)	5	5	5	5					
	Tem	perature							
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70					
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85					
	Physical	Dimension							
Length (mm)	112.75	112.75	112.75	112.75					
Width (mm)	76.00	76.00	76.00	76.00					
Height (mm)	7.50	7.50	7.50	7.50					
Weight (g)	TBD	TBD	TBD	TBD					

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(4) Random Performance is based on FIO on Linux, 4KB data size, QD=32, 16 workers.
(5) Latency is measured with random workloads based on FIO on Linux, 4KB data size, QD=1, 1 worker.
(6) Power consumption (Maximum RMS) is measured during the sequential read/write and random read/write operations performed by iometer with the conditions described in (2)(3).

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# Solution MP-X200P

Form Factor			U.2						
Capacity(1)	1.92TB	3.84TB	7.68TB	15.36TB	30.72TB				
Interface	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2				
NVMe	2.0	2.0	2.0	2.0	2.0				
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC	3D TLC				
Performance <sup>(2,3,4,6)</sup>									
Sequential Read(MB/s)	14,800	14,800	14,800	14,800	14,000 (Est.)				
Sequential Write(MB/s)	4,300	8,600	8,700	8,350	7,500 (Est.)				
4K Random Read(IOPS)	2,400K	3,000K	3,000K	3,000K	2,300K (Est.)				
16K Random Write(IOPS)	170K	380K	500K	500K	283K (Est.)				
Read Latency (Typ., µs)	60	60	60	60	60				
Write Latency (Typ., µs)	10	10	10	10	10				
	Power Consumption <sup>(5,6)</sup>								
Active (W)	<25	<25	<25	<25	<25				
Idle (W)	5	5	5	5	5				
Endurance/Reliability									
DWPD(7)	1	1	1	1	1				
UBER	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per				
UDER	10 <sup>18</sup> bits read	10 <sup>18</sup> bits read	10 <sup>18</sup> bits read	10 <sup>18</sup> bits read	10 <sup>18</sup> bits read				
MTBF (million hours)	2.5	2.5	2.5	2.5	2.5				
Limited Warranty (years)	5	5	5	5	5				
		Temperature							
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70	0 - 70				
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85	-40 - 85				
	Phy	ysical Dimension							
Length (mm)	100.10	100.10	100.10	100.10	100.10				
Width (mm)	69.85	69.85	69.85	69.85	69.85				
Height (mm)	15.00	15.00	15.00	15.00	15.00				
Weight (g)	188	199	201	168	<250				

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# Solution MP-X200P

Form Factor	E3.S							
Capacity <sup>1</sup>	1.92TB	3.84TB	7.68TB	15.36TB				
Interface	PCIe 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2	PCIe 5.0 1x4, 2x2	PCle 5.0 1x4, 2x2				
NVMe	2.0	2.0	2.0	2.0				
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC				
Performance <sup>(2,3,4,6)</sup>								
Sequential Read(MB/s)	14,800	14,800	14,800	14,800				
Sequential Write(MB/s)	4,300	8,600	8,700	8,350				
4K Random Read(IOPS)	2,400K	3,000K	3,000K	3,000K				
16K Random Write(IOPS)	170K	380K	500K	500K				
Read Latency (Typ., µs)	60	60	60	60				
Write Latency (Typ., µs)	10	10	10	10				
Power Consumption <sup>(5,6)</sup>								
Active (W)	<25	<25	<25	<25				
Idle (W)	5	5	5	5				
Endurance/Reliability								
DWPD <sup>7</sup>	1	1	1	1				
UBER	< 1 sector per	< 1 sector per	< 1 sector per	< 1 sector per				
OBER	10 <sup>18</sup> bits read	10 <sup>18</sup> bits read	10 <sup>18</sup> bits read	10 bits read				
MTBF (million hours)	2.5	2.5	2.5	2.5				
Limited Warranty (years)	5	5	5	5				
	Tem	perature						
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70				
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85				
	Physica	Dimension						
Length (mm)	112.75	112.75	112.75	112.75				
Width (mm)	76.00	76.00	76.00	76.00				
Height (mm)	7.50	7.50	7.50	7.50				
Weight (g)	TBD	TBD	TBD	TBD				

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